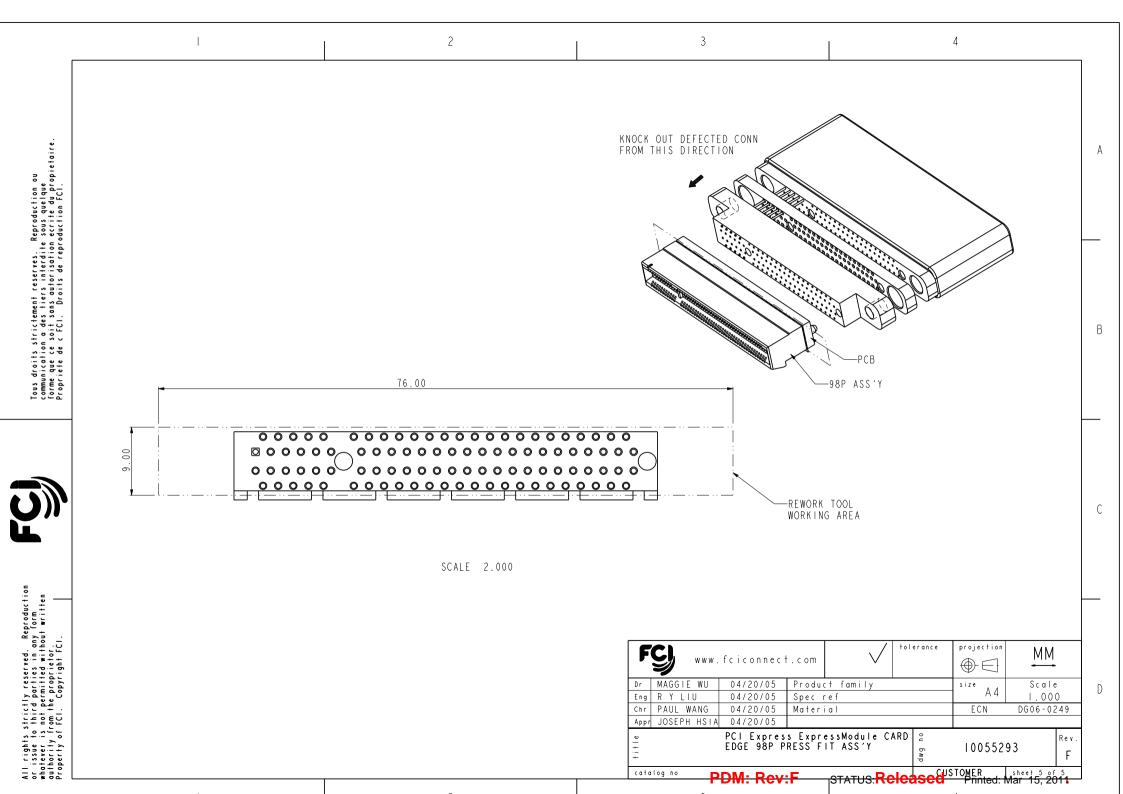


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production ou ous quelque crite du propietaire. uction FCL	NOTES: I. MATERIAL: HOUSING: HIGH TEMPERATURE NYLON, GLASS FILLED UL94V-0 RATED. SUITABLE FOR REFLOW SOLDERING. TERMINAL: COPPER ALLOY PLATING: 50u" NICKEL UNDERPLATE ALL OVER CONTACT AREA PLATING - SEE PRODUCT NUMBER CODE SOLDER TAIL: TIN - 100u" MIN. OVER 50u" NICKEL OR TIN/LEAD 100u" MIN. SEE PRODUCT NUMBER CODE 2. PRODUCT SPECIFICATION: GS-12-319 A LINE THROUGH THE CENTER OF THE HOLE PATTERN IS ESTABLISHED BY A LINE THROUGH THE CENTER OF THE HOW Ø 2.35 HOLES. THE VERTICAL AXIS IS 90" TO THE HORIZONTAL AXIS, THROUGH THE CENTER OF DATUM Z. M ON TIE BAR PERMITTED FROM CARD EDGE TO LEADING EDGE OF PAD FOR						A	
Tous droits strictement reserves. Repre communication a des tiers interdite sou forme que ce soit sons autorisation ecr Propriete de c FCL. Droits de reproduci	PINS AI AND PIN NUMBERS "F". CHAMFER EDGES MUST BE FREE OF CUTTING BURRS. ALL PLATED THRU HOLES SHOULD BE 0.76-0.83 mm DIA DRILLED AND 0.025mm ~ 0.05mm. ELECTRO-DEPOSITED COPPER THK ON THROUGH HOLE WALL. 7. ROHS COMPATIBLE PRODUCT SPECIFICATIONS a -PLATING: -"LF" MEANS THE PRODUCT IS LEAD-FREE, 2um MINIMUM MATTE TIN OVER 1.27um MINIMUM NICKEL UNDERPLATE. b-MANUFACTURING PROCESS COMPATIBILITY -THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C SOLDER BATH TEMPERATURE FOR IO SECONDS IN A REFLOW SOLDER APPLICATION WITH A 2.36mm AND 4.19mm MIN THICK CIRCUIT BOARD. PRODUCT NUMBER CODE 10055293 - X X X X X X X X X							ured B
<b>L</b>	HOUSING COLOR OPTION I-BLACK PEGS OPTIONS O-PLASTIC PEGS TERMINAL PLATING OPT 0-50u" Ni UNDERPLATE 30u" Au CONTACT A	T I ONS			RMINAL PLATING OPT K FOR TERMINAL PLA OPTIONS			C
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All righ or issue who issue who is a property					alog no <b>PDM:</b>	98P PRESS-FIT ASS Y	Eleased Printed Mar 15, 20	F 511



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